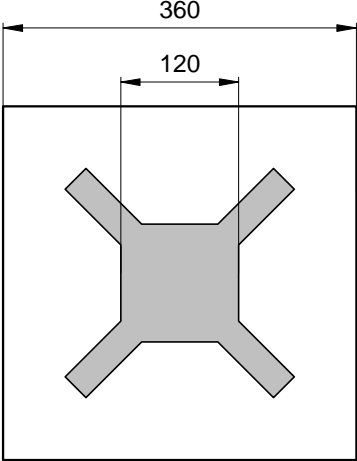


| Radiation | Type | Technology | Electrodes |
|-----------|------|---------------|--------------|
| Infrared | DDH | AlGaAs/AlGaAs | P (anode) up |

| | | |
|---|--|--|
|  <p style="text-align: center;">LED-14</p> | typ. dimensions (μm) | |
| | typ. thickness 160 (±20) μm <u>anode</u> gold alloy, 1.5 μm <u>cathode</u> gold alloy, 0.5 μm, structured, 25% covered | |

Optical and Electrical Characteristics

T_{amb} = 25°C, unless otherwise specified

| Parameter | Test conditions | Symbol | Min | Typ | Max | Unit |
|----------------------------|-------------------------|---------------------------------|-----|-------|-----|------|
| Forward voltage | I _F = 20 mA | V _F | | 1.35 | 1.6 | V |
| Reverse voltage | I _R = 100 μA | V _R | 5 | | | V |
| Radiant power ¹ | I _F = 20 mA | Φ _e | 3.5 | 5.0 | | mW |
| Radiant power ² | I _F = 20 mA | Φ _e | | 10.0 | | mW |
| Peak wavelength | I _F = 20 mA | λ _p | 860 | 875 | 890 | nm |
| Spectral bandwidth at 50% | I _F = 20 mA | Δλ _{0.5} | | 45 | | nm |
| Switching time | I _F = 20 mA | t _r , t _f | | 10/20 | | ns |

¹Measured on bare chip on TO-18 header with JENOPTIK Polymer Systems equipment

²Measured on epoxy covered chip on TO-18 header with JENOPTIK Polymer Systems equipment

Labeling

| Type | Lot N° | Φ _e (typ) [mW] | V _F (typ) [V] | Quantity |
|------------|--------|---------------------------|--------------------------|----------|
| ELC-880-17 | | | | |

Packing: Chips on adhesive film with wire-bond side on top